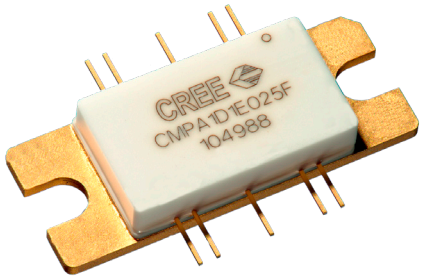
CMPA1D1E025F

25 W, 13.75 - 14.5 GHz, 40 V, Ku-Band GaN MMIC, Power Amplifier

Description

Cree's CMPA1D1E025F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC) on a silicon carbide (SiC) substrate, using a 0.25 µm gate length fabrication process. The Ku Band 25W MMIC is targeted for commercial Ku Band satellite communications applications. It offers high gain and superior efficiency while meets OQPSK linearity required for Satcom applications at 3dB backed off Psat operations. This Ku Band MMIC is available in a 10 lead, 25 mm x 9.9 mm metal/ceramic flanged package.



PN: CMPA1D1E025F
Package Type:440213

Typical Performance Over 13.75-14.5 GHz (T_c = 25˚C)

Parameter	13.75 GHz	14.0 GHz	14.25 GHz	14.5 GHz	Units
Small Signal Gain	24	24.5	24.5	24	dB
Linear Output Power	24	23	21	20	W
Power Gain	21	21	20	20	dB
Power Added Efficiency	22	20	18	18	%

Note: Measured at -30 dBc, 1.6 MHz from carrier, in the CMPA1D1E025F-AMP under OQPSK modulation, 1.6 Msps, PN23, Alpha Filter = 0.2

Features

- 24 dB Small Signal Gain
- 40 W Typical Pulsed P_{SAT}
- Operation up to 40 V
- 20 W linear power under OQPSK
- Class A/B high gain, high efficiency
  50 ohm MMIC Ku Band high power amplifier

Applications

- Satellite Communication Uplink

RoHS COMPLIANT

Absolute Maximum Ratings (not simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	V_{DSS}	120	V_{DC}	25˚C
Gate-source Voltage	V_{GS}	-10, +2	V_{DC}	25˚C
Power Dissipation	P_{DISS}	94	W	
Storage Temperature	T_{STG}	-55, +150	˚C	
Operating Junction Temperature	T_J	225	˚C	
Maximum Forward Gate Current	I_{GMAX}	10	mA	25˚C
Soldering Temperature[1]	T_S	245	˚C	
Screw Torque	τ	40	in-oz	
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	˚C/W	P_{DISS} = 94 W, 85˚C
Case Operating Temperature	T_C	-40, +85	˚C	CW, P_{DISS} = 94 W

Note: Refer to the Application Note on soldering at wolfspeed.com/rf/document-library

Electrical Characteristics (Frequency = 13.75 GHz to 14.5 GHz unless otherwise stated; T_C = 25˚C)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics[1]						
Gate Threshold	$V_{GS(TH)}$	-3.4	-3.0	-2.6	V	V_{DS} = 10 V, I_D = 18.2 mA
Gate Quiescent Voltage	V_Q	–	-2.7	–	V	V_{DS} = 40 V, I_D = 240 mA
Saturated Drain Current[2]	I_{DS}	13.1	18.2	–	A	V_{DS} = 6.0 V, V_{GS} = 2.0 V
Drain-Source Breakdown Voltage	V_{BD}	100	–	–	V	V_{GS} = -8 V, I_D = 18.2 mA
RF Characteristics[3]						
Small Signal Gain	S21	20.9	24	–	dB	V_{DD} = 40 V, I_{DQ} = 240 mA, P_{IN} = -15 dBm
Input Return Loss	S11	–	-7	-6	dB	V_{DD} = 40 V, I_{DQ} = 240 mA, P_{IN} = -15 dBm
Output Return Loss	S22	–	-7	-6	dB	V_{DD} = 40 V, I_{DQ} = 240 mA, P_{IN} = -15 dBm
Output Mismatch Stress	VSWR	–	–	5:1	Ψ	No damage at all phase angles, V_{DD} = 40 V, I_{DQ} = 240 mA, P_{OUT} = 41 dBm OQPSK

Notes:
[1] Measured on-wafer prior to packaging
[2] Scaled from PCM data
[3] Measured in the CMPA1D1E025F-AMP

Electrical Characteristics Continued (T_C = 25˚C)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
RF Characteristics[1,2,3,4]						
Power Added Efficiency	PAE1	14.5	20.5	–	%	V_{DD} = 40 V, I_{DQ} = 240 mA, Frequency = 13.75 GHz
Power Added Efficiency	PAE2	12.5	18	–	%	V_{DD} = 40 V, I_{DQ} = 240 mA, Frequency = 14.5 GHz
Power Gain	G_{P1}	19.25	23	–	dB	V_{DD} = 40 V, I_{DQ} = 240 mA, Frequency = 13.75 GHz
Power Gain	G_{P2}	17.75	22	–	dB	V_{DD} = 40 V, I_{DQ} = 240 mA, Frequency = 14.5 GHz
OQPSK Linearity	ACLR1	–	-40	-32	dBc	V_{DD} = 40 V, I_{DQ} = 240 mA, Frequency = 13.75 GHz
OQPSK Linearity	ACLR2	–	-38	-30.5	dBc	V_{DD} = 40 V, I_{DQ} = 240 mA, Frequency = 14.5 GHz

Notes:
[1] Measured in the CMPA1D1E025F-AMP
[2] Under OQPSK modulated signal, 1.6 Msps, PN23, Alpha Filter = 0.2
[3] Measured at P_{AVE} = 41 dBm
[4] Fixture loss de-embedded

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C

Typical Performance

Figure 1. Small Signal S-Parameters CMPA1D1E025F in Test Fixture
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C

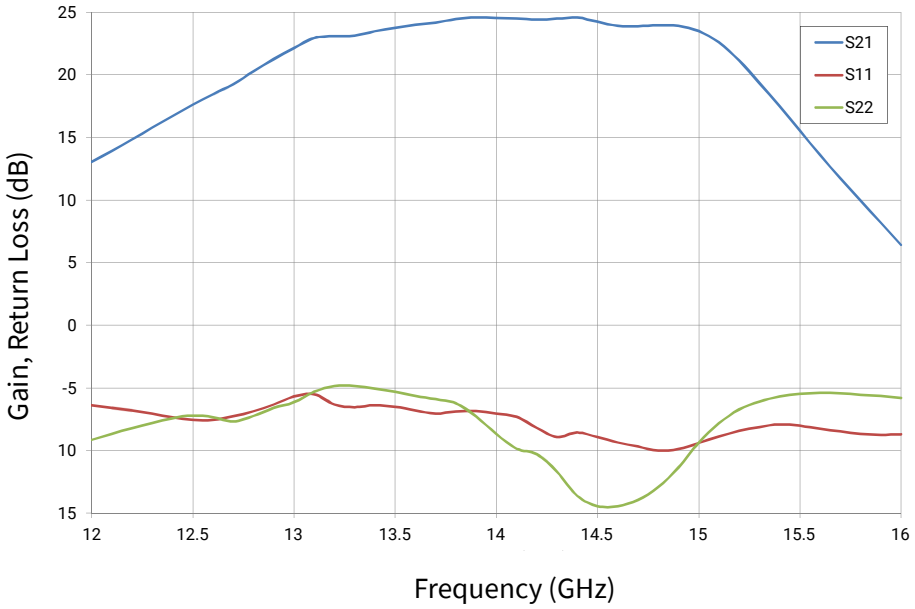
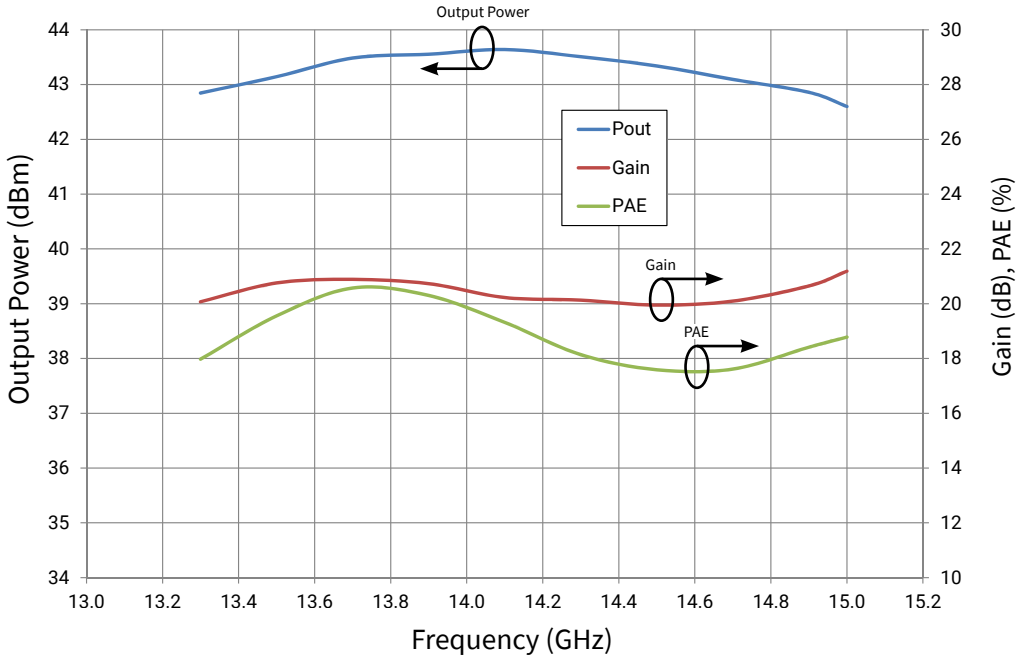


Figure 2. Modulated @ Spectral Regrowth = -30dBc, 1.6 MHz from Carrier
1.6 Msps OQPSK Modulation
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C



Typical Performance

Figure 3. Spectral Mask @ Average Output Power = 41 dBm
1.6 Msps OQPSK Modulation
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C

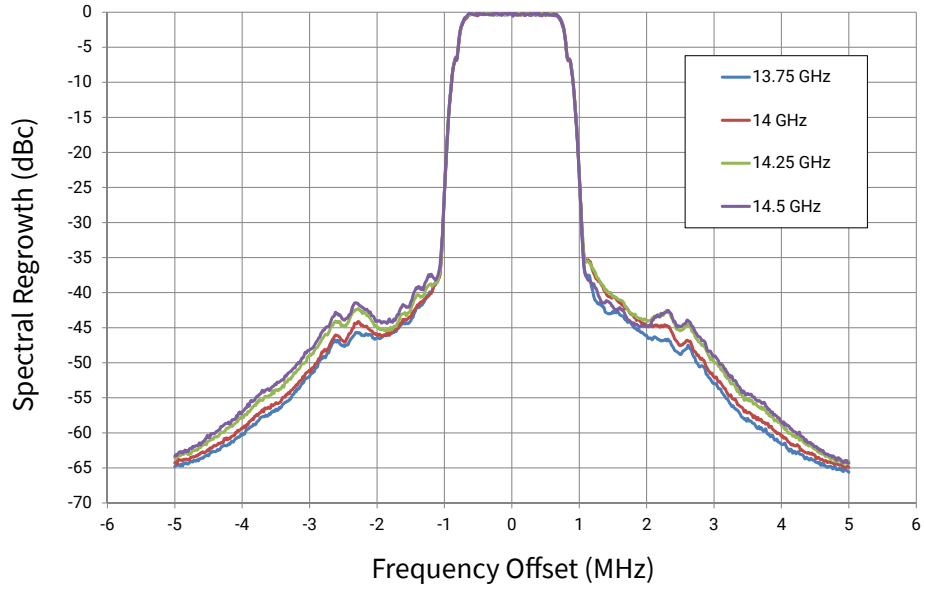
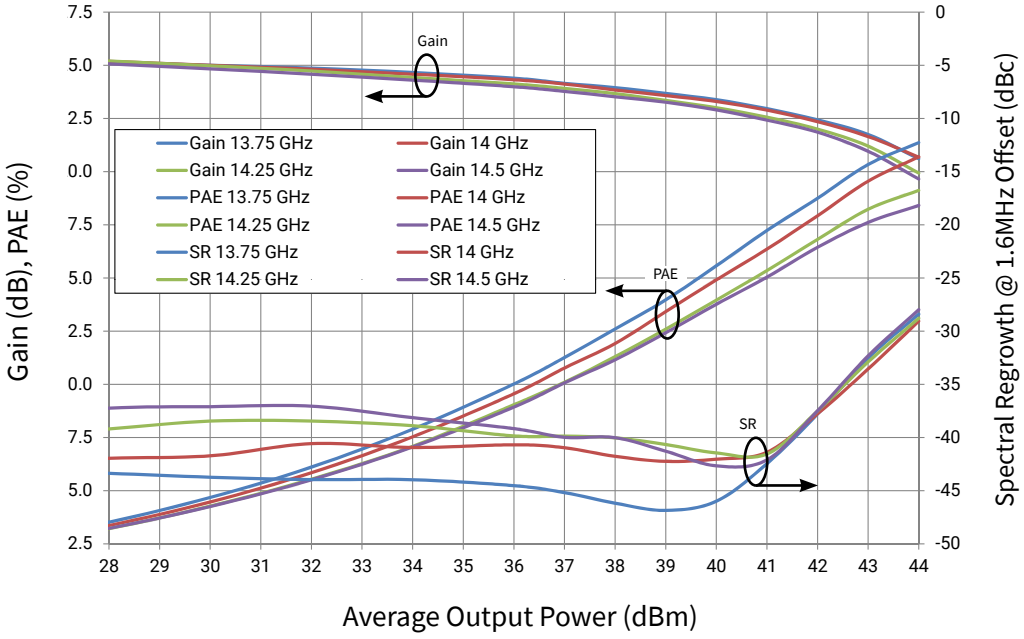


Figure 4. CMPA1D1E025F Modulated Power Sweep
1.6 Msps OQPSK Modulation
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C



Typical Performance

Figure 5. Modulated Power Sweep
1.6 Msps OQPSK Modulation
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C

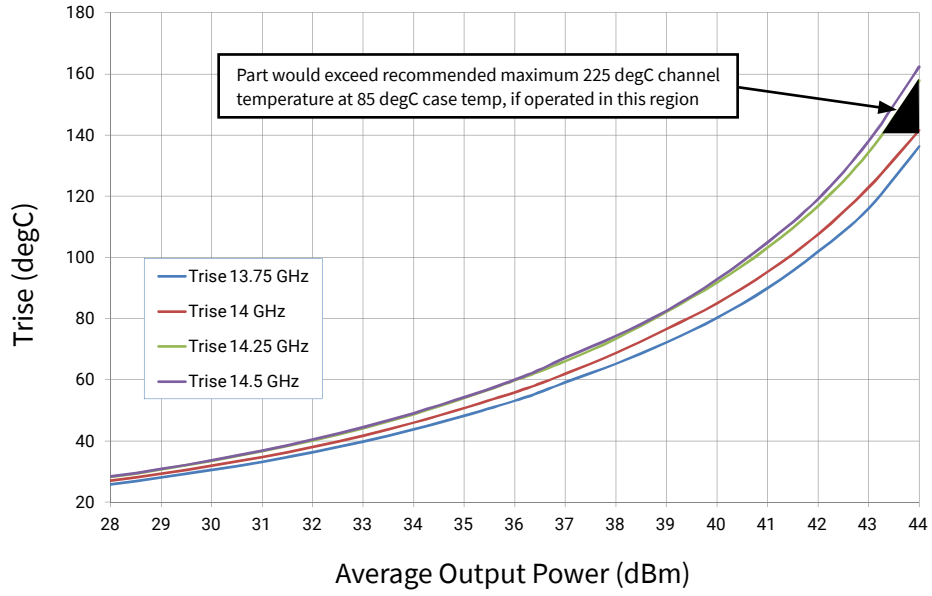
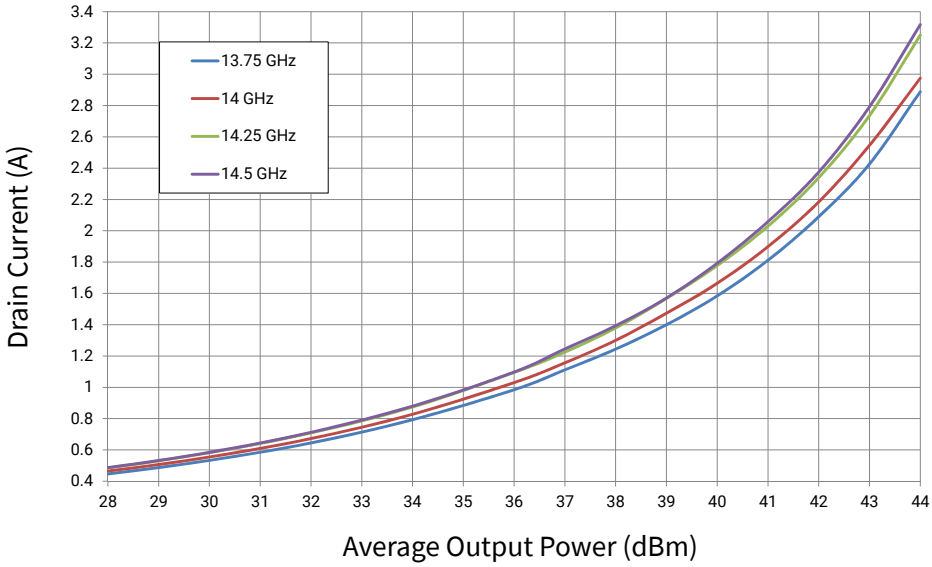


Figure 6. CMPA1D1E025F Modulated Power Sweep
1.6 Msps OQPSK Modulation
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C



Typical Performance

Figure 7. CMPA1D1E025F Two Tone Power Sweep
IMD3 @ 1 MHz Carrier Spacing
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C

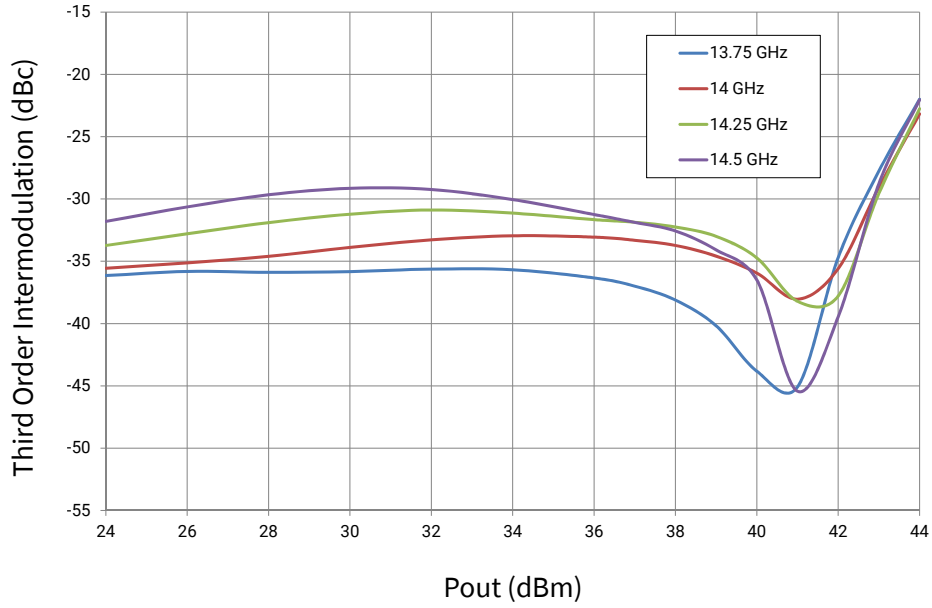
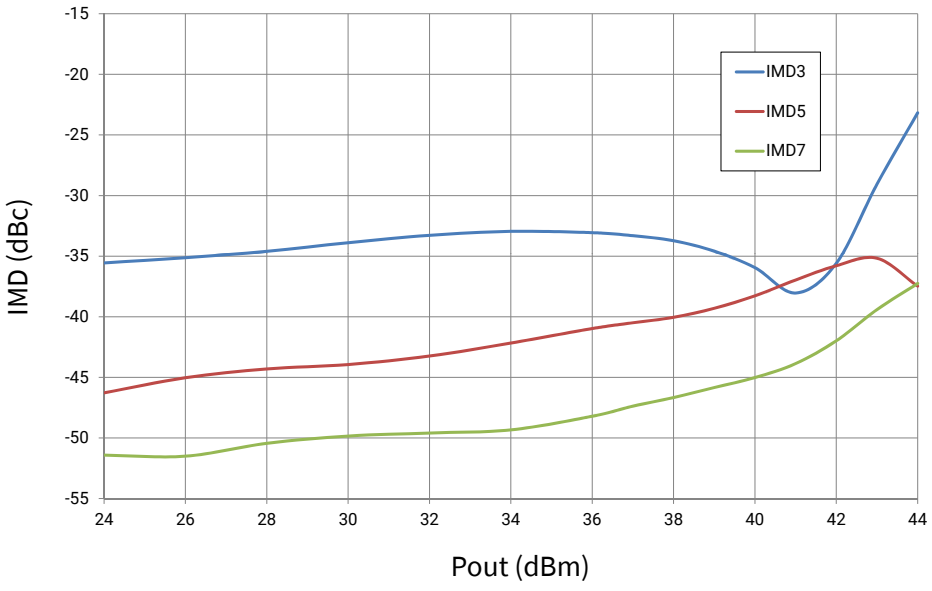


Figure 8. Two Tone Power Sweep
IMD @ 1 MHz Carrier Spacing, 14 GHz
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C



Typical Performance

Figure 9. Two Tone Carrier Spacing Sweep @ 38 dBm Average Ouput Power, 14 GHz
V_{DD} = 40 V, I_{DQ} = 1 A, Tcase = 25°C

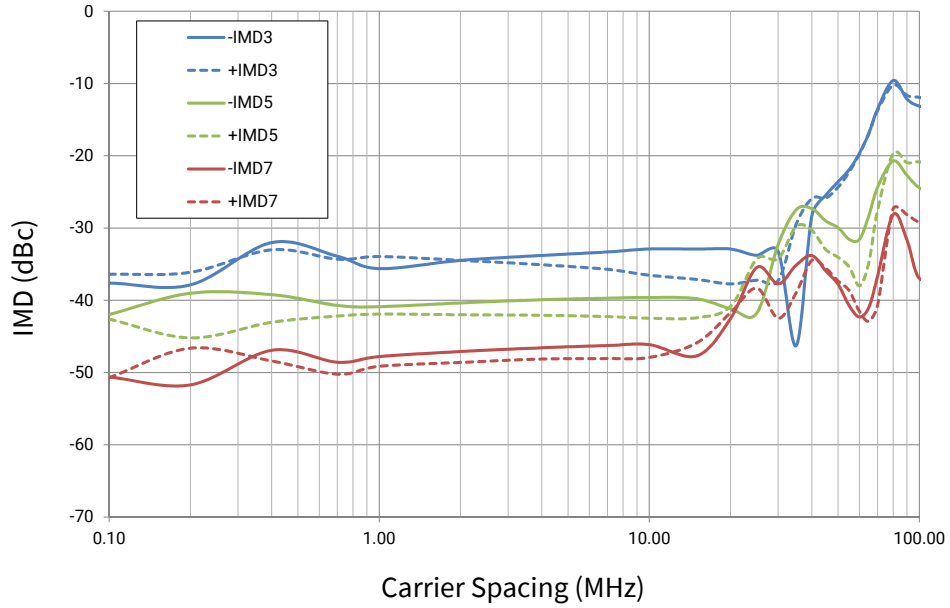
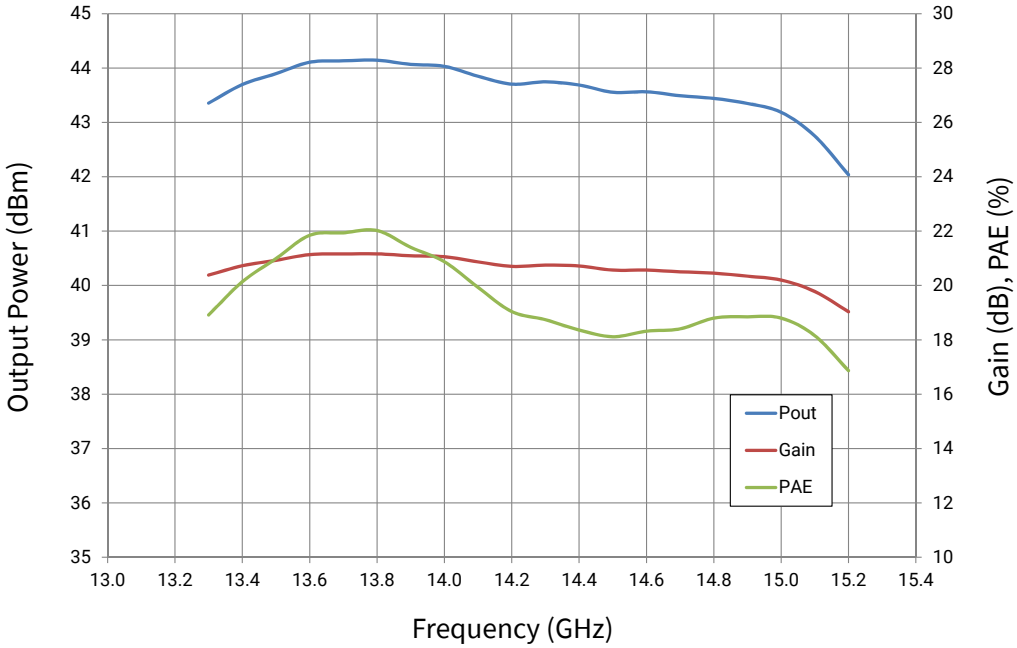


Figure 10. CW vs. Frequency @ P_{IN} = 23 dBm
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C



Typical Performance

Figure 11. CW Power Sweep CMPA1D1E025F in Test Fixture
V_{DD} = 40V, I_{DQ} = 240 mA, Tcase = 25°C

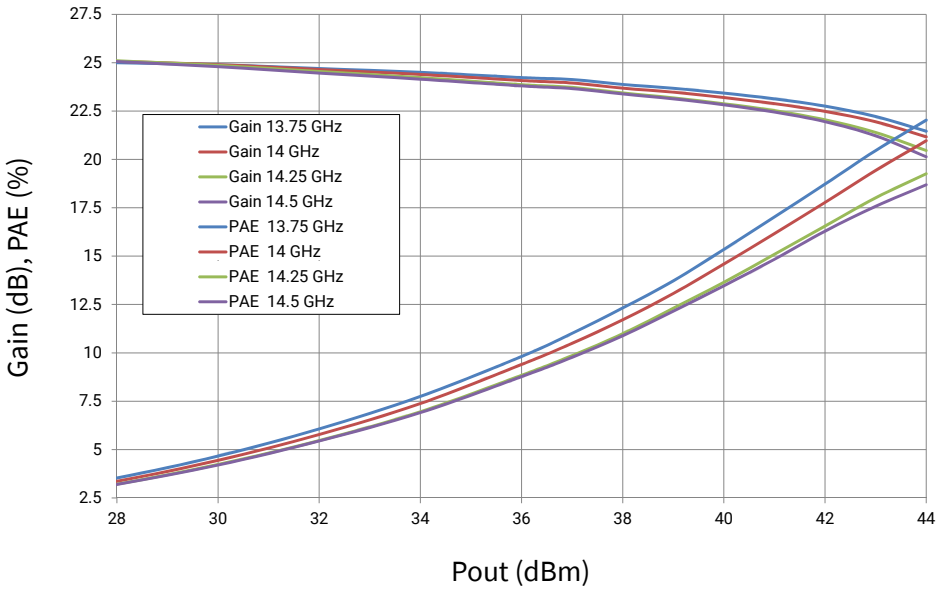
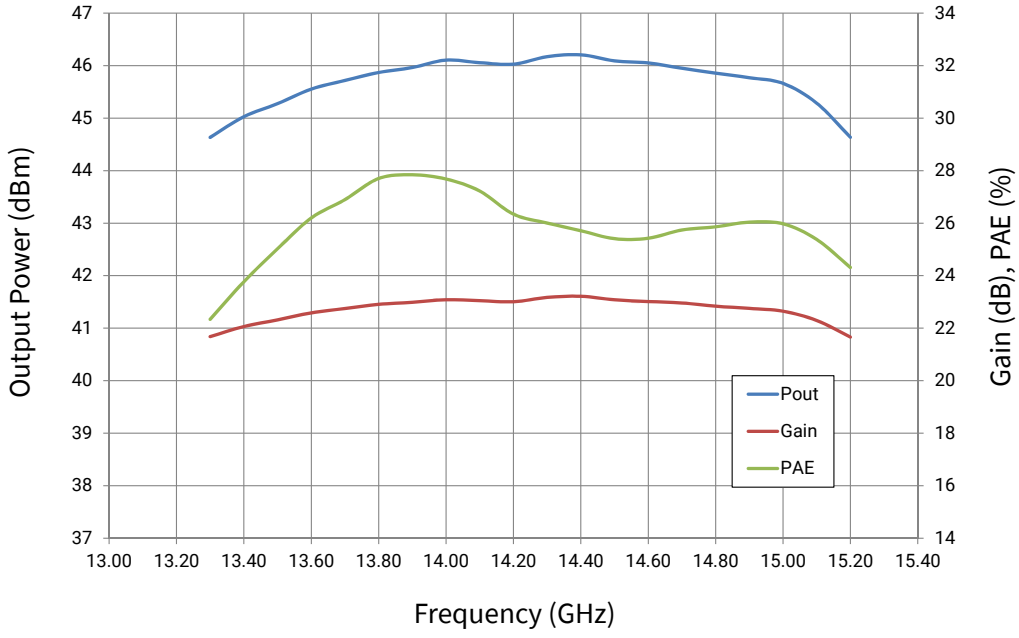


Figure 12. Pulsed vs. Frequency @ PIN = 23 dBm CMPA1D1E025F in Test Fixture
V_{DD} = 40 V, I_{DQ} = 240 mA, 100 uS Pulse Width, 10% Duty Cycle, Tcase = 25°C



Typical Performance

Figure 13. Pulsed Power Sweep CMPA1D1E025F in Test Fixture
10% Duty, 100 uS Pulse Width
V_{DD} = 40V, I_{DQ} = 240 mA, Tcase = 25°C

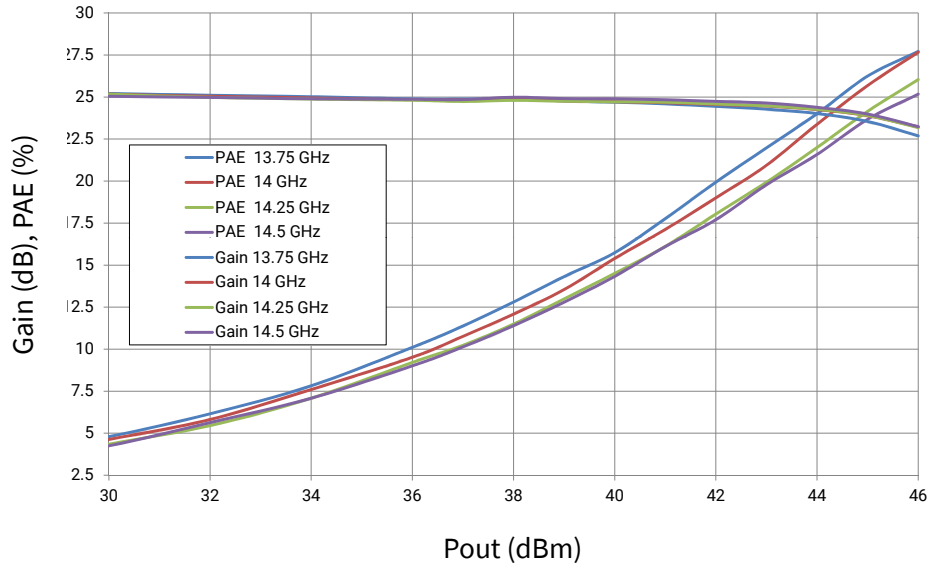
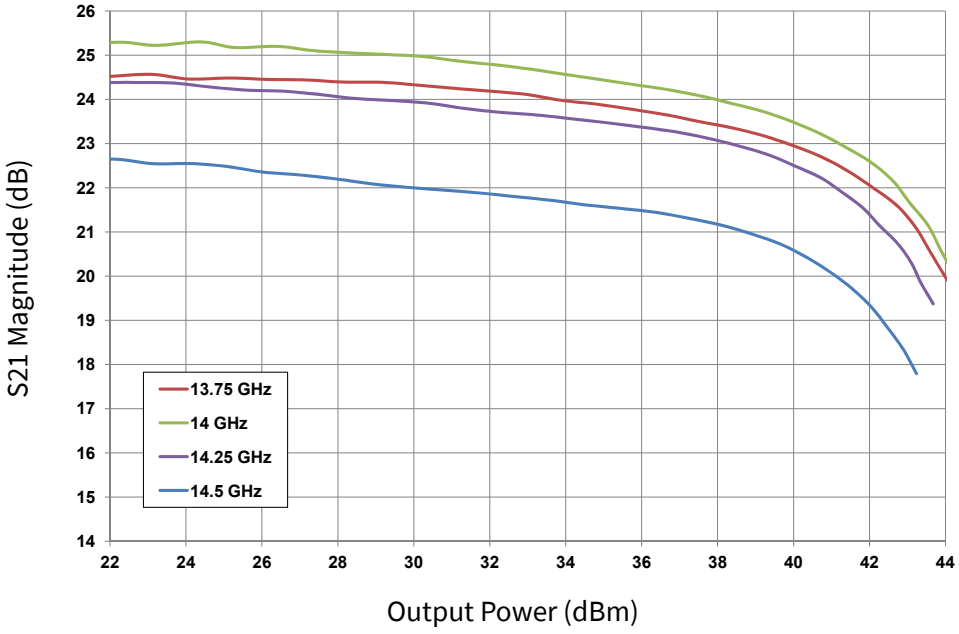


Figure 14. AM-AM
V_{DD} = 40 V, I_{DQ} = 240 mA, Tcase = 25°C



Typical Performance

Figure 15. AM-PM
V_{DD} = 40V, I_{DQ} = 240 mA, Tcase = 25°C

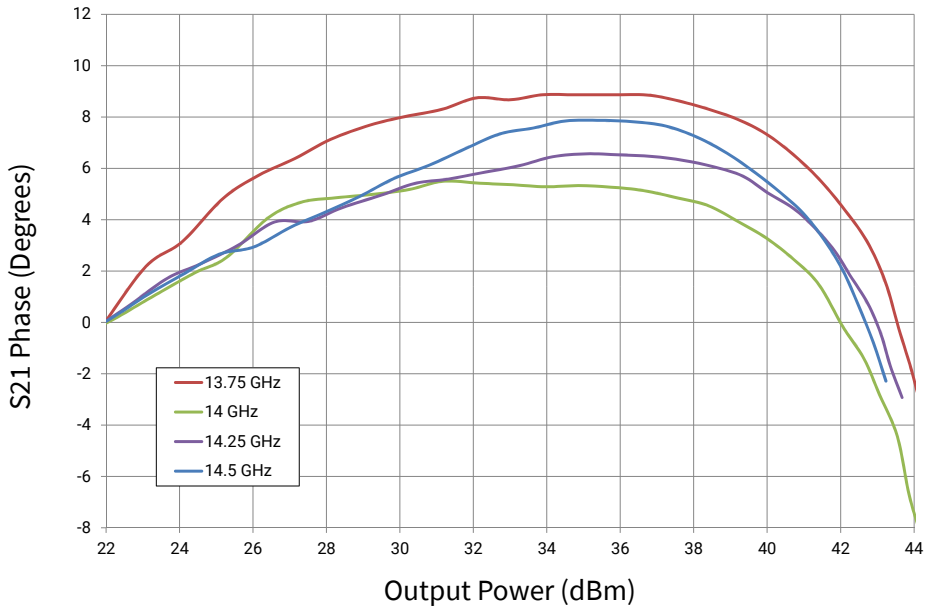
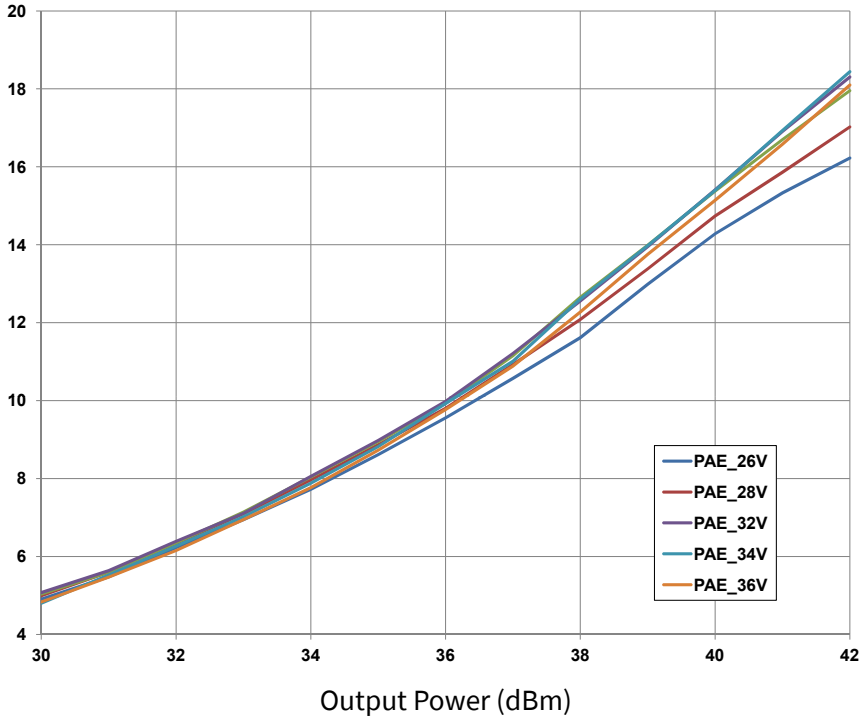


Figure 16. CMPA1D1E025F Modulated Power Sweep (PAE and Gp)
1.6 Msps OQPSK Modulation, Frequency = 14 GHz
V_{DD} = 26-36 V, I_{DQ} = 150 mA, Tcase = 25°C



Typical Performance

Figure 17. CMPA1D1E025F Modulated Power Sweep (Gp)
1.6 Msps OQPSK Modulation, Frequency = 14 GHz
V_{DD} = 26-36 V, I_{DQ} = 150 mA, Tcase = 25°C

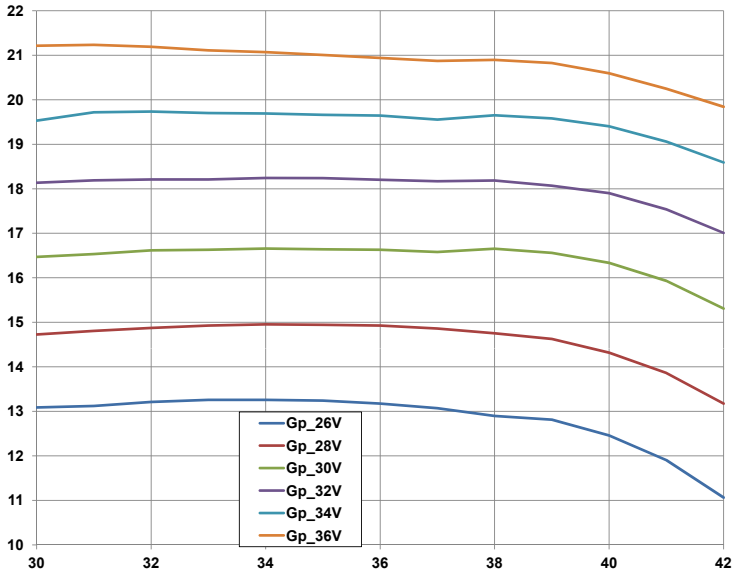
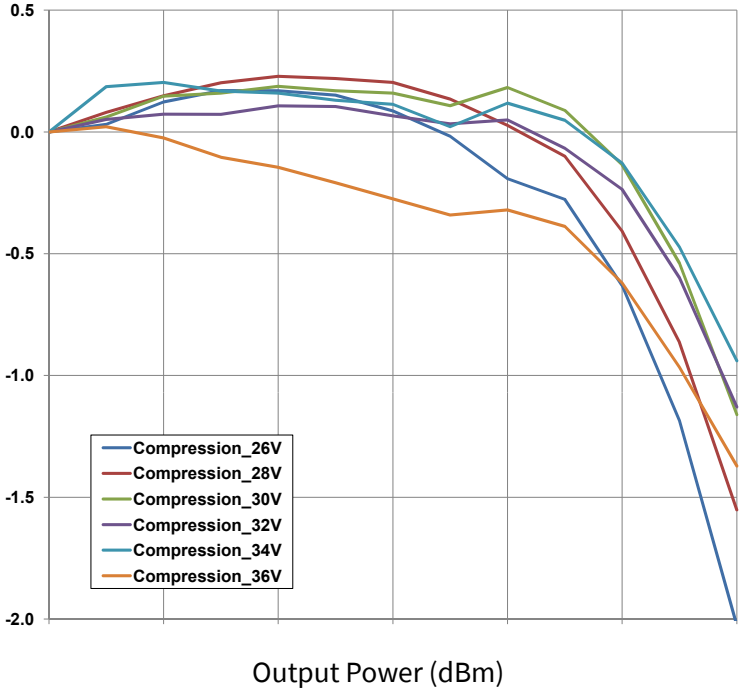
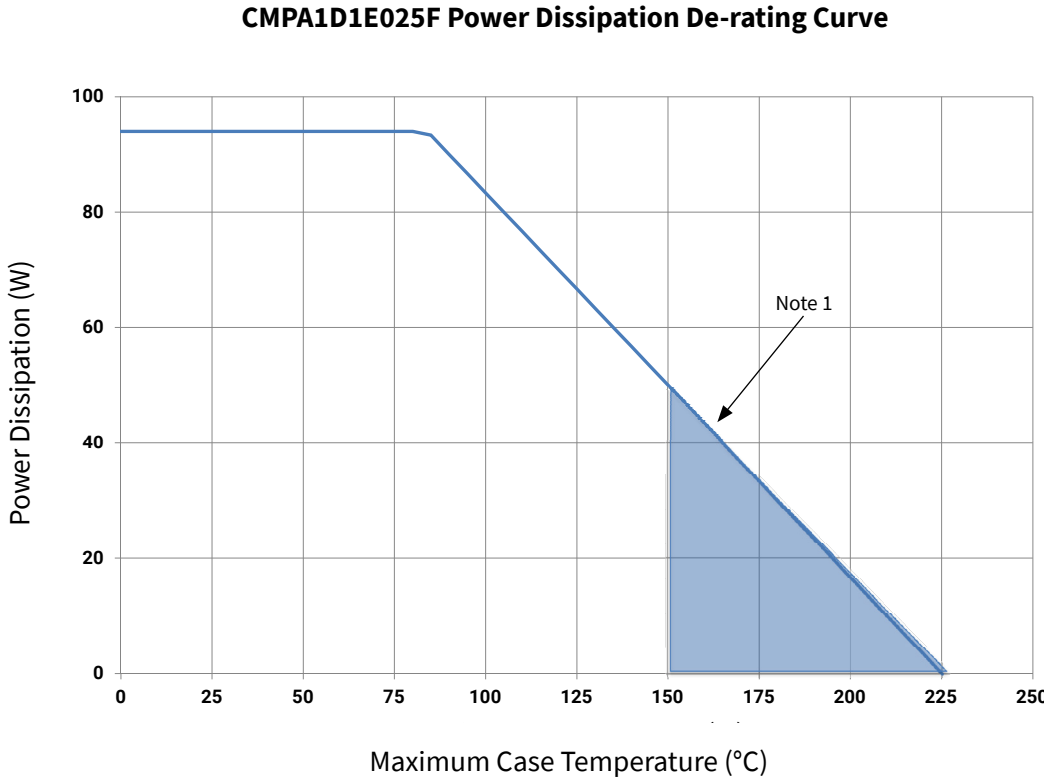


Figure 18. CMPA1D1E025F Modulated Power Sweep (Gain Compression)
1.6 Msps OQPSK Modulation, Frequency = 14 GHz
V_{DD} = 26-36 V, I_{DQ} = 150 mA, Tcase = 25°C



Typical Performance

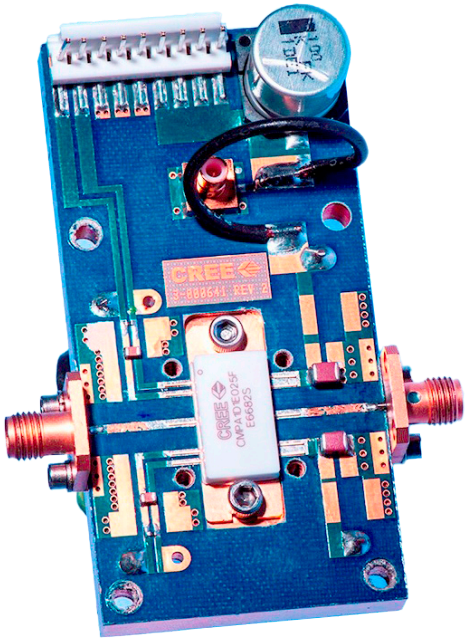


Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2)

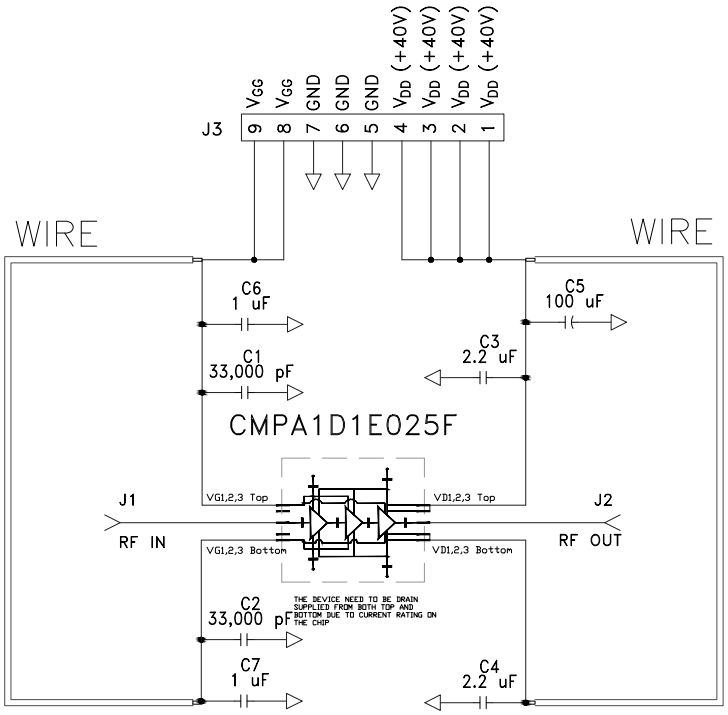
CMPA1D1E025F-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
C5	CAP ELECT 100UF 80V AFK SMD	1
C1, C2	CAP, 33000PF, 0805,100V, X7R	2
C3, C4	CAP, 2.2UF, 100V, 10%, X7R, 1210	2
C6, C7	CAP, 1.0UF, 100V, 10%, X7R, 1210	2
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J3	HEADER RT>PLZ .1CEN LK 9POS	1
W1, W2, W3	WIRE, BLACK, 22 AWG	1
	PCB, TEST FIXTURE, TACONICS RF35P, 20 MILS	1
	2-56 SOC HD SCREW 3/16 SS	4
-	#2 SPLIT LOCKWASHER SS	4
Q1	CMPA1D1E025F	1

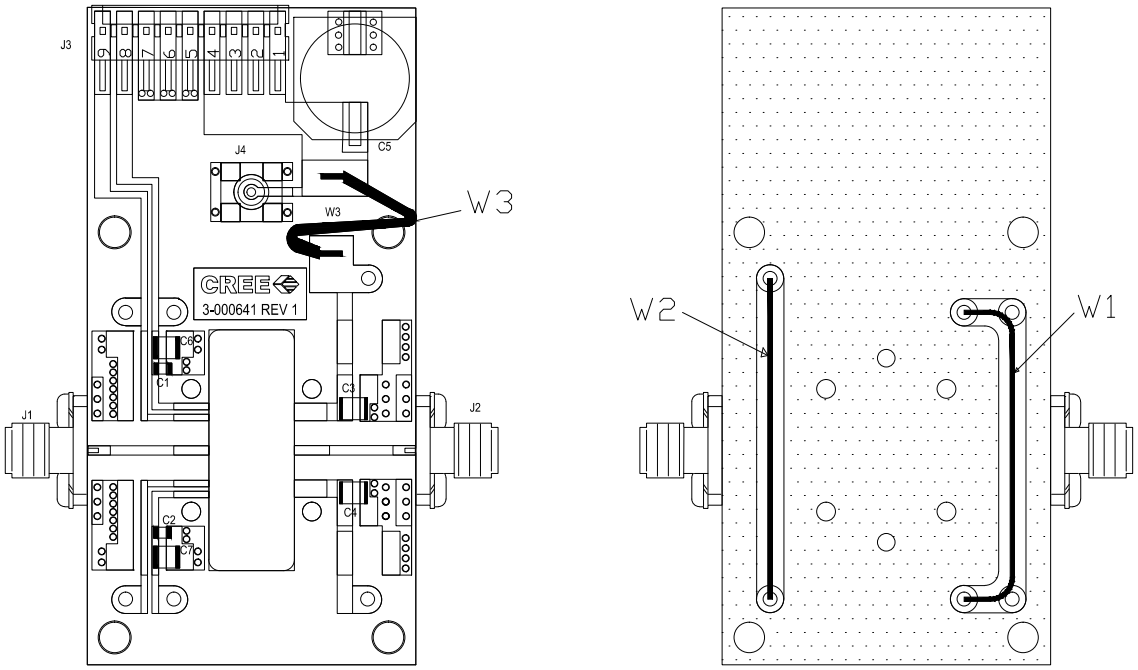
CMPA1D1E025F-AMP Demonstration Amplifier Circuit



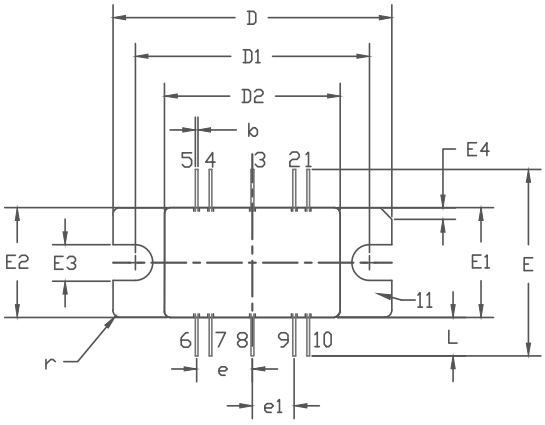
CMPA1D1E025F-AMP Demonstration Amplifier Circuit Schematic

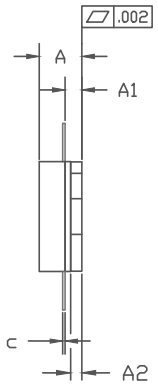


CMPA1D1E025F-AMP Demonstration Amplifier Circuit Outline



Product Dimensions CMPA1D1E025F (Package Type — 440213)





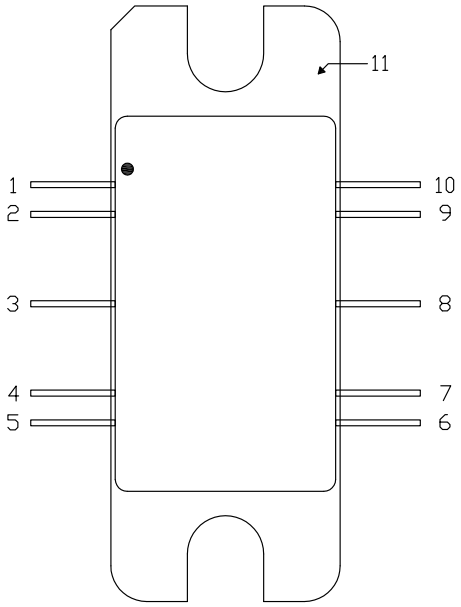
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M – 1994.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

	INCHES		MILLIMETERS		NOTES
DIM	MIN	MAX	MIN	MAX	
A	0.148	0.168	3.76	4.27	
A1	0.055	0.065	1.40	1.65	
A2	0.035	0.045	0.89	1.14	
b	0.01 TYP		0.254 TYP		10x
c	0.007	0.009	0.18	0.23	
D	0.995	1.005	25.27	25.53	
D1	0.835	0.845	21.21	21.46	
D2	0.623	0.637	15.82	16.18	
E	0.653 TYP		16.59 TYP		
E1	0.380	0.390	9.65	9.91	
E2	0.380	0.390	9.65	9.91	
E3	0.120	0.130	3.05	3.30	
E4	0.035	0.045	0.89	1.14	45° CHAMFER
e	0.200 TYP		5.08 TYP		4x
e1	0.150 TYP		3.81 TYP		4x
L	0.115	0.155	2.92	3.94	10x
r	0.025 TYP		.635 TYP		3x

PIN 1: GATE BIAS 6: DRAIN BIAS
2: GATE BIAS 7: DRAIN BIAS
3: RF IN 8: RF OUT
4: GATE BIAS 9: DRAIN BIAS
5: GATE BIAS 10: DRAIN BIAS
11: SOURCE

Pin Number	Qty
1	Gate Bias
2	NC
3	RF In
4	NC
5	Gate Bias
6	Drain Bias
7	Drain Bias
8	RF Out
9	Drain Bias
10	Drain Bias
11	Source



Part Number System

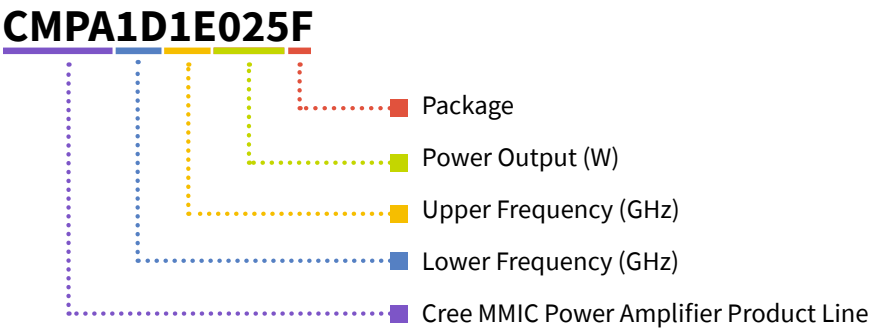


Table 1.

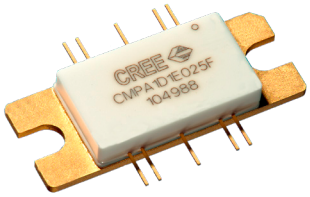
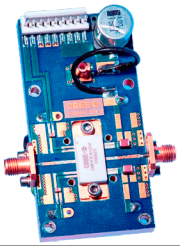
Parameter	Value	Units
Lower Frequency	13.75	GHz
Upper Frequency[1]	14.5	GHz
Power Output	25	W
Package	Flange	-

Note[1]: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value

Table 2.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CMPA1D1E025F	GaN HEMT	Each	
CMPA1D1E025F-AMP	Test board with GaN HEMT installed	Each	

For more information, please contact:

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RF Product Marketing Contact
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Notes

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